

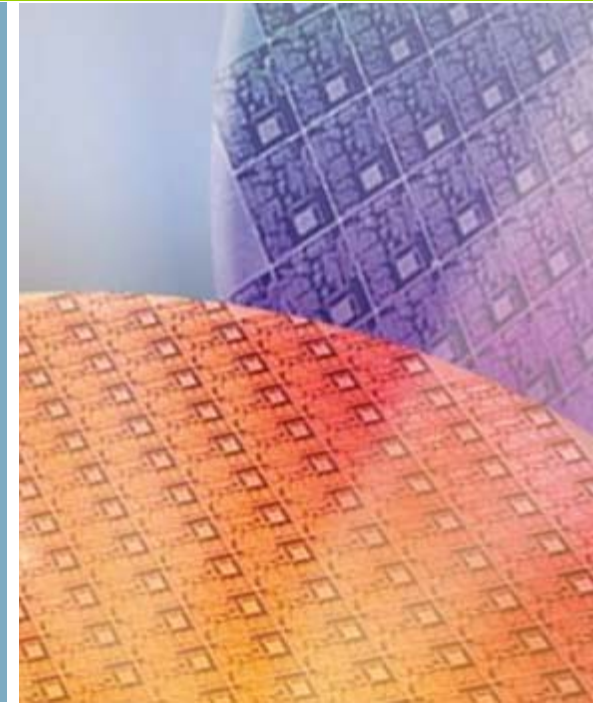
# Development of X-ray Tool For Critical- Dimension Metrology

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# Overview



- Introduction
- Pilot set-up
- Software package
- Sample and alignment
- Experimental results
- XRR measurement for height
- Conclusions

# Why X-rays?

- OCD and CD-SEM limitations
- Nodes 32 nm and below
- Negative slopes existing in some structures
- First principle method (no libraries required)

## **Current status of CD-SAXS:**

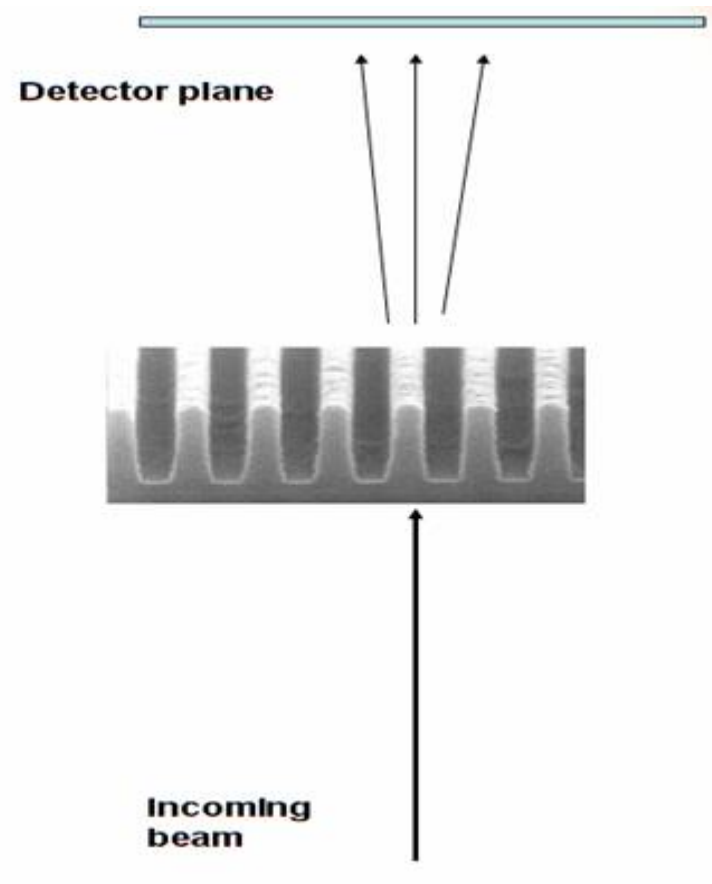
*Based on NIST publications, the technology delivers a promising capabilities for current and future design nodes, while using synchrotron radiation as a source*

## **Goal of this research:**

assessing feasibility of making an X-ray tool of laboratory scale, allowing characterization of CD-structures with measurement times suitable for production control

# Small Angle X-ray Scattering (CD-SAXS, or XCD™)

- Diffraction of highly collimated monochromatic X-ray beam on a periodic structure
- Intensity as a function of angle
- Transmission mode vs reflection mode
- Why 17.4 keV
- Spot size 100  $\mu$
- Physical dimensions of the set-up
- Vertical beam
- No-vacuum X-ray path  
~1,300 mm



# Pilot set-up – major physical components

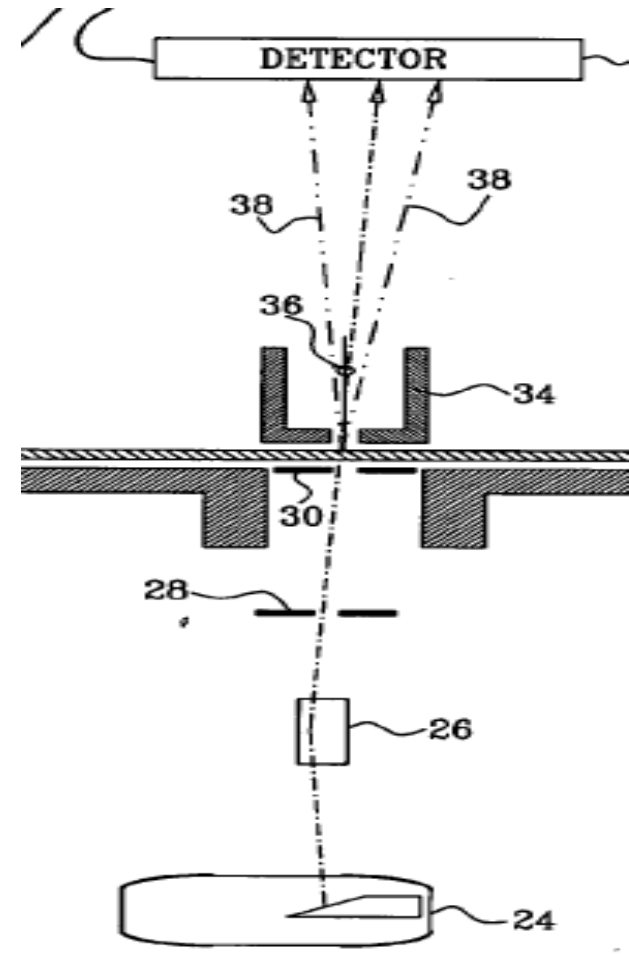
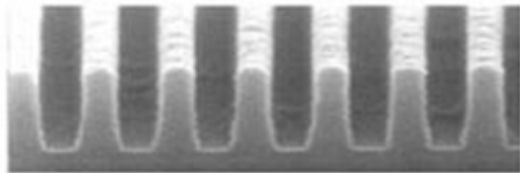
- $\mu$ -focus X-ray tube (Mo anode, operated at 50 kV, 50 W)
- focusing monochromator (doubly bent graded multilayer mirror with 100  $\mu$  spot size)
- deep depletion CCD operated in the direct detection mode
- additional very important gadgets: set of slits, beam stopper

# Software package

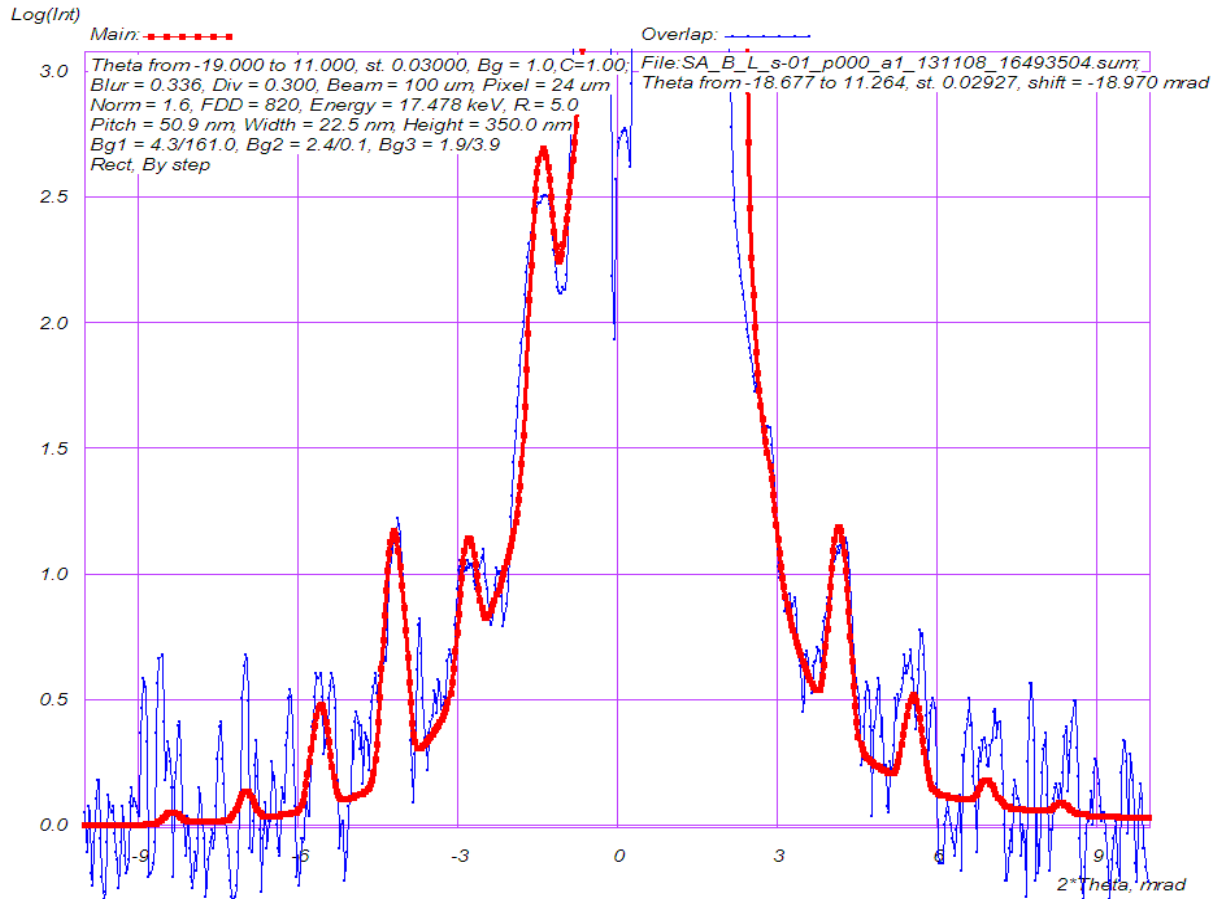
- Simulation of the XCD signal takes into account all the components contributing to the instrumental function of the system
- Beam divergence, beam cross-section, detector pixel size
- Background modeling based on experimental spectra
- Statistical fluctuations on/off
- Normalization to experimentally measured intensities
- Selection of various shapes (rectangular, trapezoid, etc.)
- Processing of experimental spectra by fitting based on Genetic Algorithms

# Sample and alignment

- Special sample for initial evaluation
- Si lines 50 nm pitch, aspect ratio 6
- High density contrast
- Features few mm<sup>2</sup> area - simplified navigation
- Special technique to align CD-lines direction on the sample with the detector CCD pixels direction



# Experimental XCD spectrum



X-ray Critical Dimensions and OverLay | Ready

Show  
 Main  Over  Main 2D  Over 2D 2\*Theta, mrad

2\*Theta, mrad

Param	Nom	Best	Min	Max	Fit
Pitch, nm	50.93	50.93	25	102	<input checked="" type="checkbox"/>
Width, nm	22.50	22.50	11	45	<input checked="" type="checkbox"/>
TWidth, nm	31.67	31.67	16	63	<input type="checkbox"/>
Height, nm	350.00	350.00	175	700	<input type="checkbox"/>
Slope, deg	0.29	0.29	0.14	0.58	<input type="checkbox"/>
Norm.	1.6	1.6	0.79	3.2	<input checked="" type="checkbox"/>
Rough, nm	2.9	2.9	1.4	5.7	<input checked="" type="checkbox"/>
BG	0.98	0.98	0.49	2.0	<input checked="" type="checkbox"/>
Bg1 Right	4.3	4.3	2.2	8.6	<input checked="" type="checkbox"/>
Bg2 Right	2.4	2.4	1.2	4.9	<input checked="" type="checkbox"/>
Bg3 Right	1.9	1.9	0.96	3.9	<input checked="" type="checkbox"/>
Bg1 Left	161	161	81	322	<input checked="" type="checkbox"/>
Bg2 Left	0.05	0.05	0.02	0.10	<input checked="" type="checkbox"/>
Bg3 Left	3.9	3.9	1.9	7.7	<input checked="" type="checkbox"/>
Width2, nm	10	10	5.0	20	<input type="checkbox"/>
Height2, nm	100	100	50	200	<input type="checkbox"/>
Shift, nm	20	20	10	40	<input type="checkbox"/>

Control  
 Build As Main  Build As Overlap  Swap  D-M On  Noise Quant

GA Fit  
 Range, mrad        
      
      Spike Cor.  
 -->M  Auto Angle Range

# Extracted absolute values: XCD vs other methods

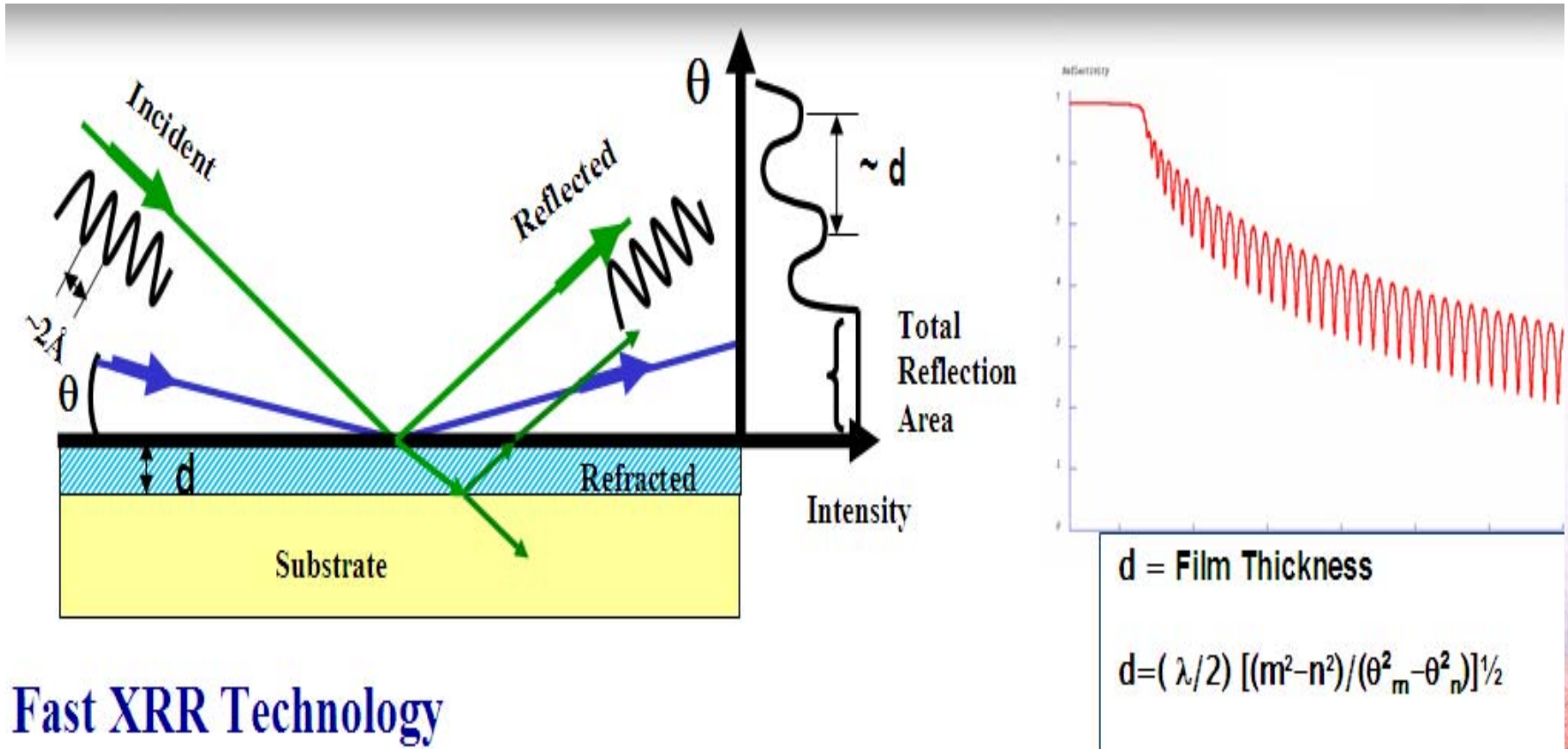
**TABLE 1.** Pitch and width values.

	<b>Pitch, nm</b>	<b>Width, nm</b>
XCD value found on feature 11L1	50.8	22.6
XCD value found on feature 11R1	50.4	22.6
values known from SEM and OCD measurements	50.0	22.4 (OCD) 23.9 (SEM)

# XCD results – static repeatability

<b>location</b>	<b>#</b>	<b>pitch, nm</b>	<b>width, nm</b>
11L1	1	51.0	22.9
11L1	2	50.4	22.8
11L1	3	51.1	22.1
11L1	4	51.1	23.2
11L1	5	50.9	22.1
11L1	6	50.6	22.3
11L1	7	50.9	23.5
11L1	8	50.8	22.2
11L1	9	50.7	22.4
<b>average</b>		50.8	22.6
<b>RSD, %</b>		0.5	2.2

# Height measurement with the fast XRR channel

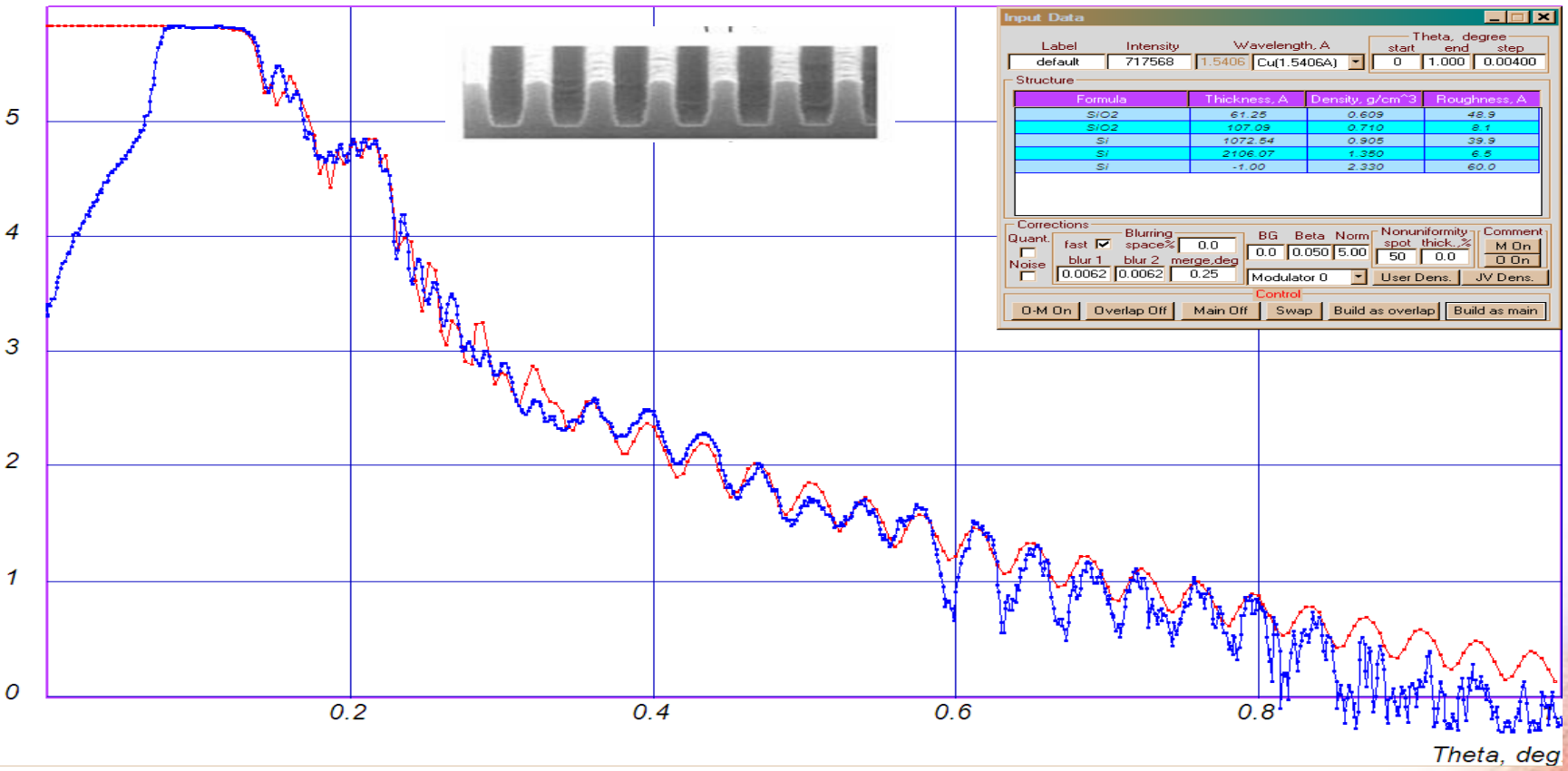


## Fast XRR Technology

Fast: simultaneous irradiation in the entire angle range;  
simultaneous detection of reflections in the entire angle range

# Experimental fast XRR spectrum from the CD structure

Reflectivity



Height obtained from XRR fringes: 316 nm;  
 Height as measured by SEM: 310 nm

# XCD channel - potential luminosity increase

- Mirror-monochromator efficiency: 10-15 times
- Detector efficiency: 10-15 times
- Tube power: 5-6 times
- Overall: ~ 1,000 times
- Acquisition time for Si lines: ~ 7 s
- Acquisition time for photo resist lines:  
in the range 10 - 100 s

# Discussion and conclusions

- Development of a production control worthy XCD tool is feasible
- Another important application for such tool might be the overlay metrology
- Further R&D is required for selection and combining major physical components
- A substantial engineering challenge in the project will be mechanical design for sample inclination and navigation on such wafer



# THANK YOU FOR YOUR ATTENTION

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